g GE Energy	Functional Testing Specification		
Parts & Repair Services Louisville, KY	LOU-GENEVA-IS200TPIM		
Test Procedure for IS200TPIM cards tested on the GENEVA Test System			
DOCUMENT REVISION STATUS: Determined by the last entry in the "REV" an			
REV. DESCRIPTION  A Initial release	SIGNATURE REV. DATE		
A Initial release	R. Johnson 7/31/2012		
В			
С			
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### Functional test procedure for IS200TPIM cards tested on the GENRAD® GENEVA system

#### 1. SCOPE

**1.1** This is a functional testing procedure for IS200TPIM boards.

## 2. STANDARDS OF QUALITY

**2.1** Refer to the current revision of the IPC-A-610 standard for workmanship standards.

## 3. APPLICABLE DOCUMENTS

- **3.1** The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.
  - **3.1.1** Check the board's electronic folder for more information.

### 4. ENGINEERING REQUIREMENTS

- 4.1 Equipment Cleaning
  - **4.1.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to site specific SRA's for cleaning guidelines.
- 4.2 Equipment Inspection
  - **4.2.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
    - 4.2.1.1 Wires broken or cracked
    - **4.2.1.2** Terminal strips / connectors broken or cracked
    - **4.2.1.3** Loose wires
    - 4.2.1.4 Components visually damaged
    - 4.2.1.5 Capacitors leaking
    - 4.2.1.6 Solder joints damaged or cold
    - 4.2.1.7 Circuit board burned or de-laminated
    - 4.2.1.8 Printed wire runs burned or damaged

### 5. EQUIPMENT REQUIRED

**5.1** The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1	H188912	GENRAD Geneva Test System
1	H190025	TPIM Test Fixture

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# 6. Testing Process

- 6.1 Setup
  - **6.1.1** Install fixture H190025 onto Geneva test System.
  - **6.1.2** Install UUT into test fixture.
- 6.2 Testing Procedure
  - **6.2.1** Load appropriate test program and follow instructions on screen.
- 6.3 \*\*\*TEST COMPLETE \*\*\*

### 7. Notes

- **7.1** Changes to the electronic test file are located in the following directory on the local hard drive; C:\Geneva\Geneva\Geneva\Test Fixture Notes.
  - **7.1.1** These changes have been backed up on CD.

# 8. Attachments

8.1 Picture of the Geneva Test System

